

PUR hot melt adhesive 71301-B

Introduction

71301-B is a single-component moisture-curing hot melt adhesive with solid content of 100%. It can be used to bond plastics such as PC, ABS, PVC and other metals such as aluminum and stainless steel.

Benefits:

- High initial bond strength
- Viscosity stability
- High peel strength after curing
- Good chemical resistance
- Humidity resistance

Application

- 71301-B package is suitable for all kinds of dispensing equipment.
- Recommended melt/sizing temperature: 110 °C
- Storage conditions suggested in 23 ~ 25 °C, relative humidity 65%.
- Special cleaner is required for cleaning equipment

Pretreatment:

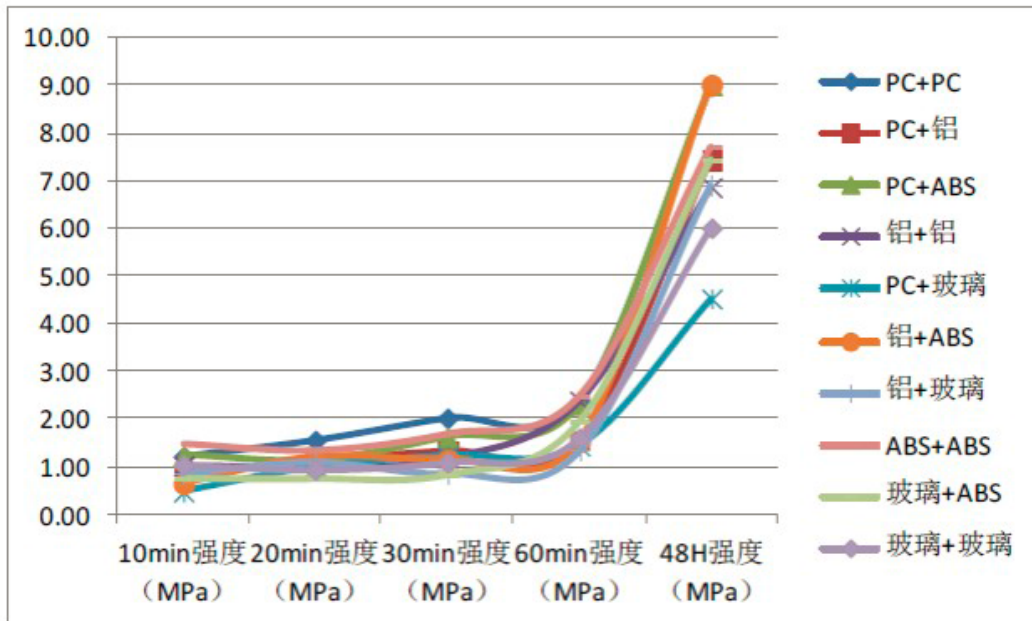
Before coating, remove oil, wax, dust and other impurities from the surface of the base material to ensure excellent adhesion.

Chemical and physical properties

Property	Test Methods	Result
Appearance	visual inspection	Black products
Exposure time		2~4 min @ 25°C
Viscosity, (mPa.s)	Brookfield-ASTM D3236	1800~4500 cps @ 110°C

Performance Parameter:

Shear strength time curve of different substrates



Package

71301-B

30cc

Environmental Policy

Techspray ® committed to the development of environmentally friendly products, our products comply with federal, state, or local government laws and regulations.

Relevant Information

Asia
ITW Specialty
Materials(Suzhou)Co.,Ltd Heng Qiao
Road, Wujiang Economic Development
Zone, Suzhou, Jiangsu, China, 215200

Tel: +86-512 8206 0808

Fax: +86-512 8206 0010